

DATA SHEET

74F125, 74F126 Quad buffers (3-State)

Product specification
IC15 Data Handbook

1989 March 28

Quad buffers (3-State)

74F125, 74F126

FEATURE

- High impedance NPN base inputs for reduced loading (20µA in High and Low states)

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F125	5.0ns	23mA
74F126	5.0ns	26mA

ORDERING INFORMATION

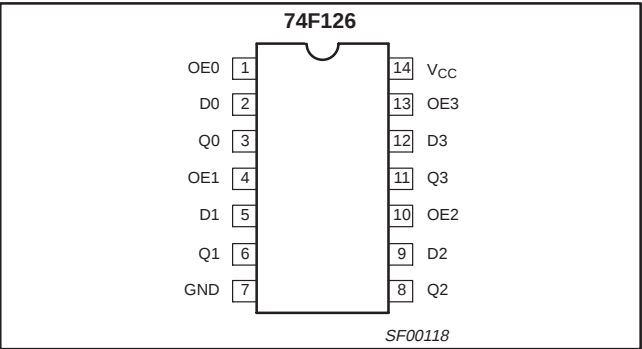
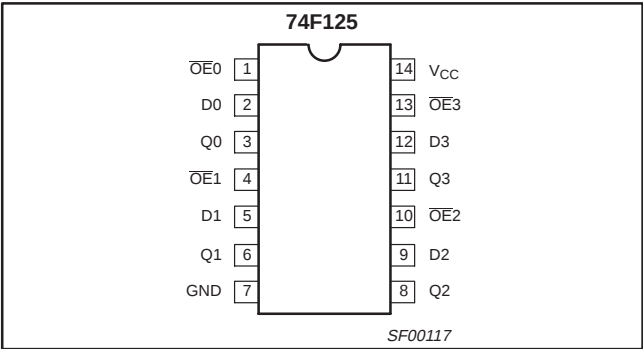
DESCRIPTION	COMMERCIAL RANGE V _{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	PKG DWG #
14-pin plastic DIP	N74F125N, N74F126N	SOT27-1
14-pin plastic SO	N74F125D, N74F126D	SOT108-1

INPUT AND OUTPUT LOADING AND FAN OUT TABLE

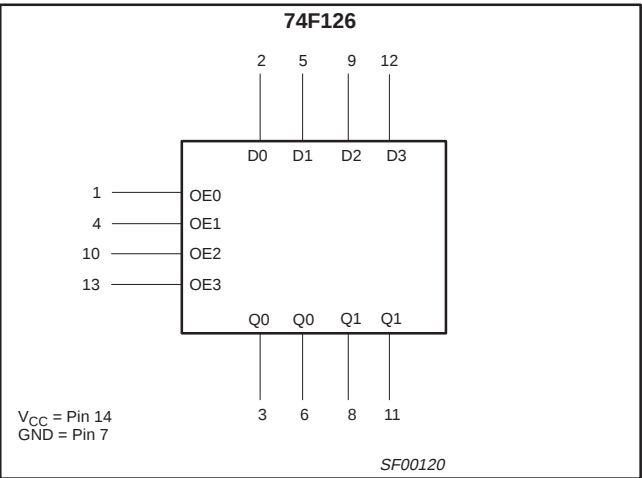
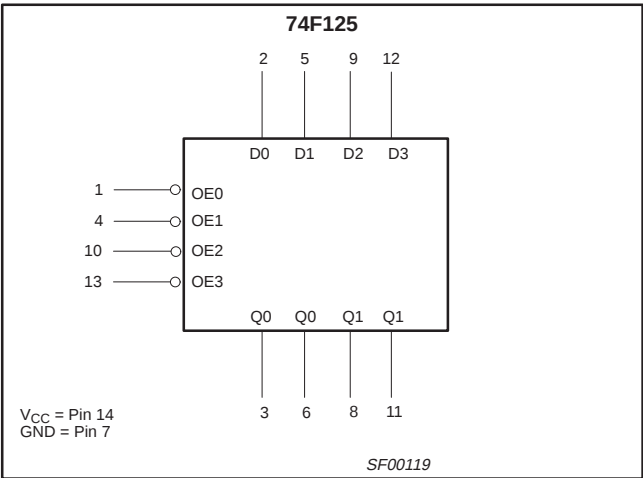
PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
D0–D3	Data inputs	1.0/0.033	20µA/20µA
$\overline{OE}0$ – $\overline{OE}3$	Output Enable inputs (active Low), 74F125	1.0/0.033	20µA/20µA
OE0–OE3	Output Enable inputs (active High), 74F126	1.0/0.033	20µA/20µA
Q0–Q3	Data outputs	750/106.7	15mA/64mA

NOTE: One (1.0) FAST unit load is defined as: 20µA in the High state and 0.6mA in the Low state.

PIN CONFIGURATIONS



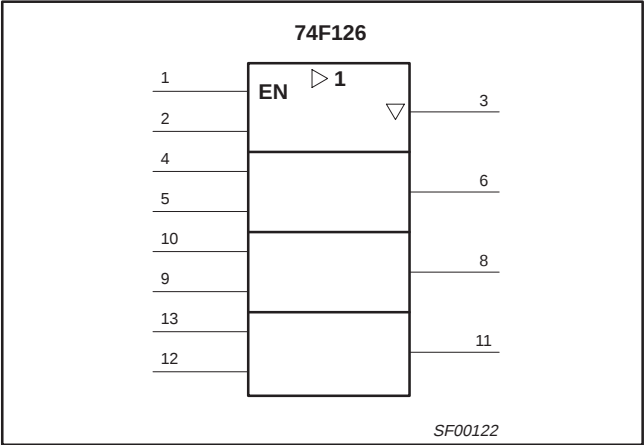
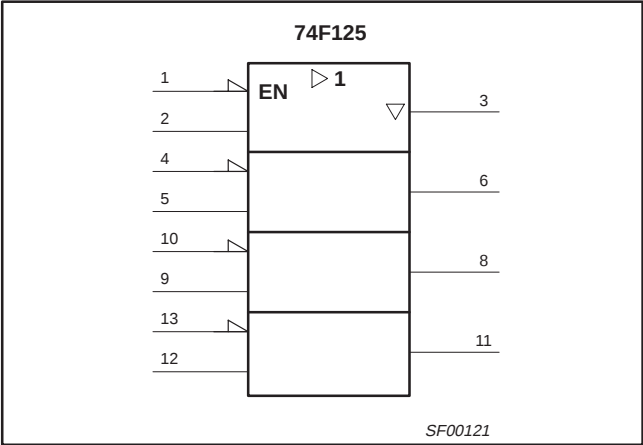
LOGIC SYMBOLS



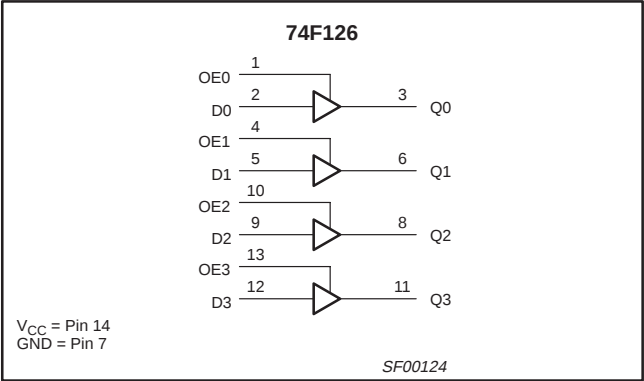
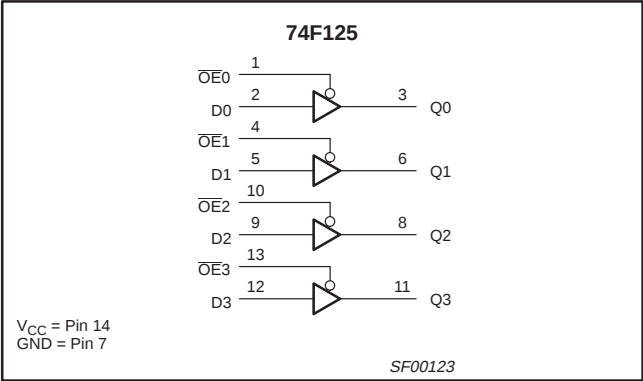
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IEC/IEEE SYMBOLS



LOGIC DIAGRAMS



FUNCTION TABLE, 74F125

I INPUTS		OUTPUT
$\overline{OEn}$	Dn	Qn
L	L	L
L	H	H
H	X	Z

FUNCTION TABLE, 74F126

I INPUTS		OUTPUT
OEn	Dn	Qn
H	L	L
H	H	H
L	X	Z

NOTES TO THE FUNCTION TABLES:

H = High voltage level
L = Low voltage level
X = Don't care
Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	−0.5 to +7.0	V
V _{IN}	Input voltage	−0.5 to +7.0	V
I _{IN}	Input current	−30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	−0.5 to V _{CC}	V
I _{OUT}	Current applied to output in Low output state	128	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	−65 to +150	°C

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I_{IK}	Input clamp current			-18	mA
I_{OH}	High-level output current			-15	mA
I_{OL}	Low-level output current			64	mA
T_{amb}	Operating free air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS ¹			LIMITS			UNIT
						MIN	TYP ²	MAX	
V _{OH}	High-level output voltage		V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN	I _{OH} = −3mA	±10%V _{CC}	2.4			V
					±5%V _{CC}	2.7	3.3		V
				I _{OH} = −15mA	±10%V _{CC}	2.0			V
					±5%V _{CC}	2.0			V
V _{OL}	Low-level output voltage		V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN	I _{OH} = MAX	±10%V _{CC}			0.55	V
					±5%V _{CC}		0.42	0.55	V
V _{IK}	Input clamp voltage		V _{CC} = MIN, I _I = I _{IK}				−0.73	−1.2	V
I _I	Input current at maximum input voltage		V _{CC} = 0.0V, V _I = 7.0V					100	μA
I _{IH}	High-level input current		V _{CC} = MAX, V _I = 2.7V					20	μA
I _{IL}	Low-level input current		V _{CC} = MAX, V _I = 0.5V					−20	μA
I _{OZH}	Off-state output current, High-level voltage applied		V _{CC} = MAX, V _O = 2.7V					50	μA
I _{OZL}	Off-state output current, Low-level voltage applied		V _{CC} = MAX, V _O = 0.5V					−50	μA
I _{OS}	Short circuit output current ³		V _{CC} = MAX			−100		−225	mA
I _{CC}	Supply current (total)	74F125	I _{CCH}	V _{CC} = MAX	OE̅n = GND, Dn = 4.5V		17	24	mA
			I _{CCL}		OE̅n = Dn = GND		28	40	mA
			I _{CCZ}		OE̅n = Dn = 4.5V		25	35	mA
		74F126	I _{CCH}	V _{CC} = MAX	OEn = Dn = 4.5V		20	30	mA
			I _{CCL}		OEn = 4.5V, Dn = GND		32	48	mA
			I _{CCZ}		OEn = GND, Dn = 4.5V		26	39	mA

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at $V_{CC} = 5\text{V}$, $T_{amb} = 25^\circ\text{C}$.
- Not more than one output should be shorted at a time. For testing I_{OS} , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

Quad buffers (3-State)

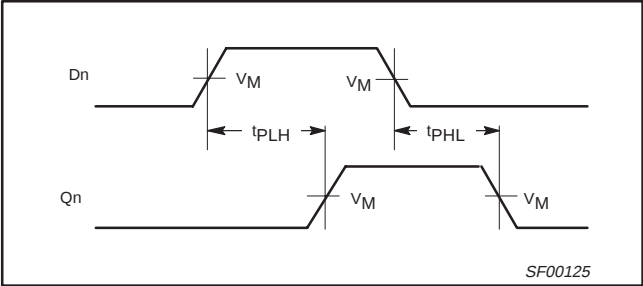
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AC ELECTRICAL CHARACTERISTICS

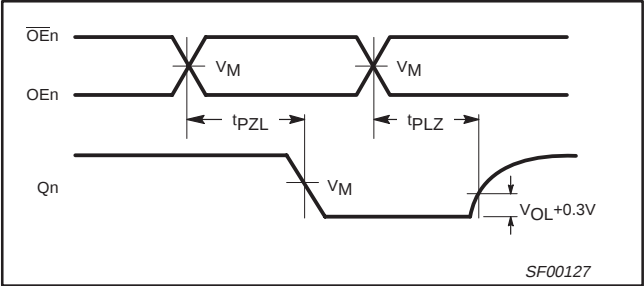
SYMBOL	PARAMETER		TEST CONDITION	LIMITS					UNIT
				V _{CC} = +5.0V T _{amb} = +25°C C _L = 50pF, R _L = 500Ω			V _{CC} = +5.0V ± 10% T _{amb} = 0°C to +70°C C _L = 50pF, R _L = 500Ω		
				MIN	TYP	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay Dn to Qn	74F125	Waveform 1	2.0 3.0	4.0 5.5	6.0 7.5	2.0 3.0	6.5 8.0	ns
t _{PZH} t _{PZL}	Output Enable time to High or Low level		Waveform 2 Waveform 3	3.5 4.0	5.5 6.0	7.5 8.0	3.5 4.0	8.5 9.0	ns
t _{PHZ} t _{PLZ}	Output Disable time from High or Low level		Waveform 2 Waveform 3	1.5 1.5	3.5 3.5	5.0 5.5	1.5 1.5	6.0 6.0	ns
t _{PLH} t _{PHL}	Propagation delay Dn to Qn	74F126	Waveform 1	2.0 3.0	4.0 5.5	6.5 8.0	2.0 3.0	7.0 8.5	ns
t _{PZH} t _{PZL}	Output Enable time to High or Low level		Waveform 2 Waveform 3	4.0 4.0	6.0 6.0	7.5 8.0	3.5 3.5	8.5 8.5	ns
t _{PHZ} t _{PLZ}	Output Disable time from High or Low level		Waveform 2 Waveform 3	2.0 3.0	4.5 5.5	6.5 7.5	2.0 3.0	7.5 8.0	ns

AC WAVEFORMS

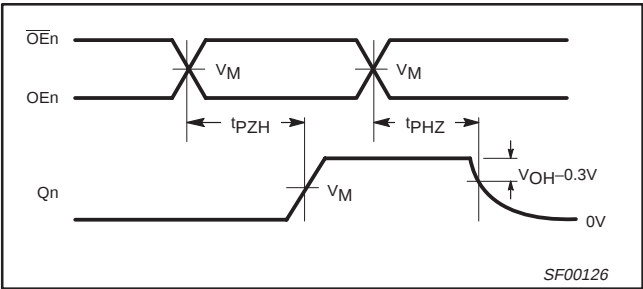
For all waveforms, $V_M = 1.5V$.



Waveform 1. Propagation Delay for Input to Output



Waveform 3. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

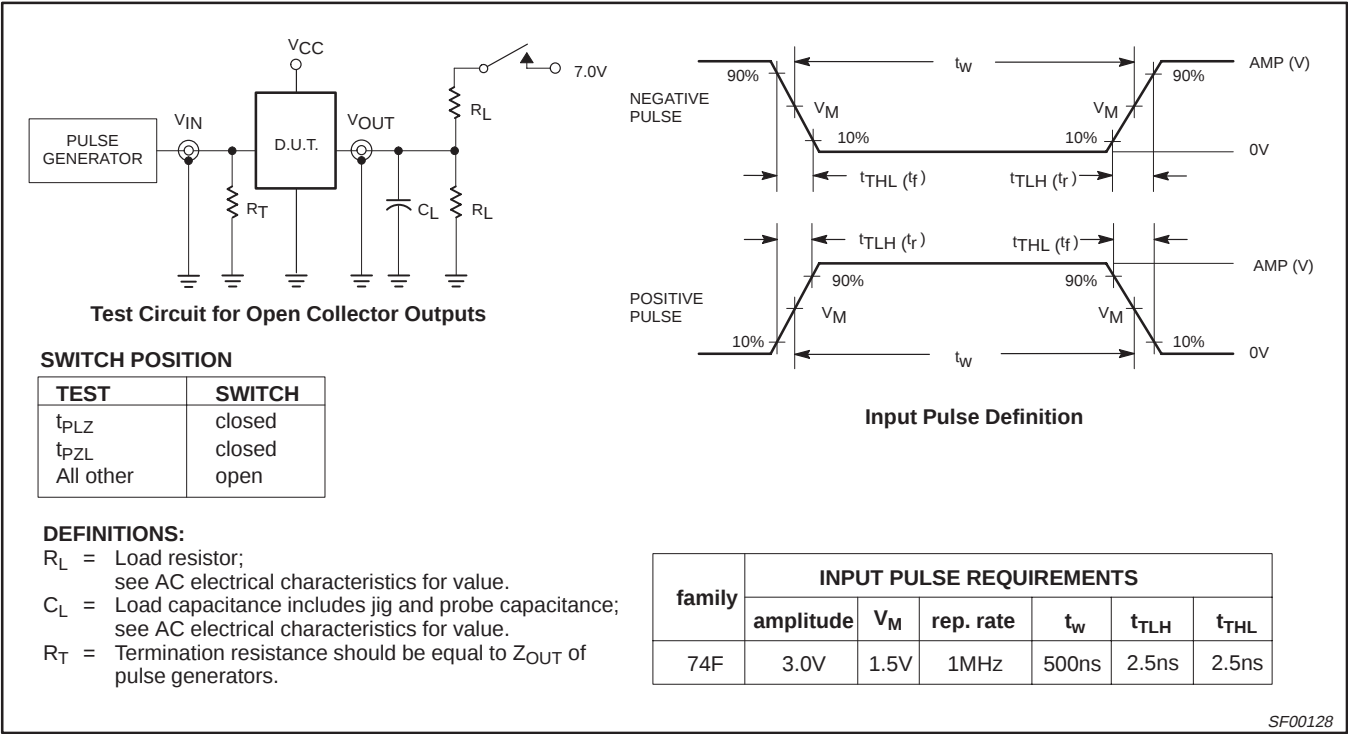


Waveform 2. 3-State Output Enable Time to High Level and Output Disable Time from High Level

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TEST CIRCUIT AND WAVEFORM

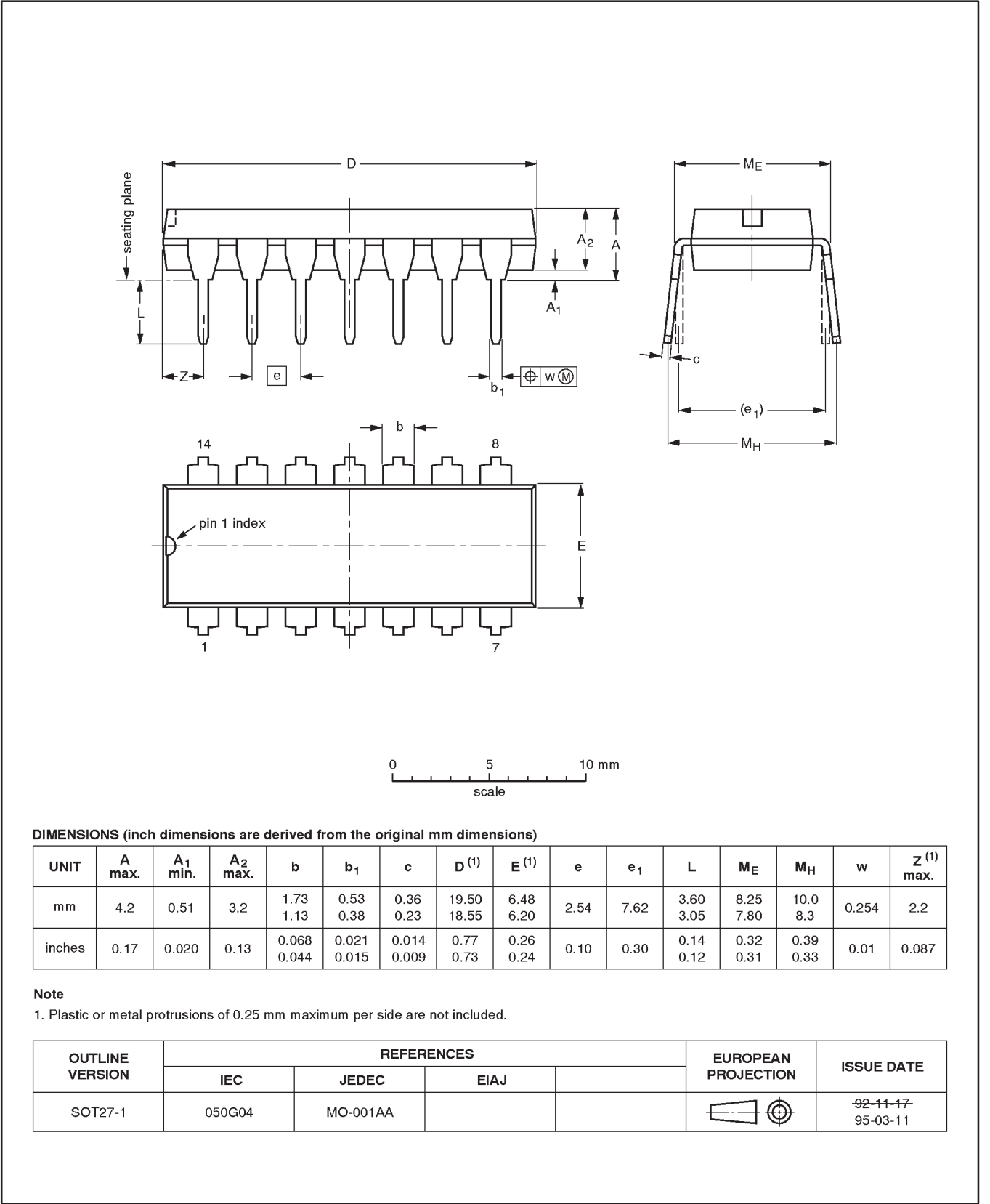


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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1

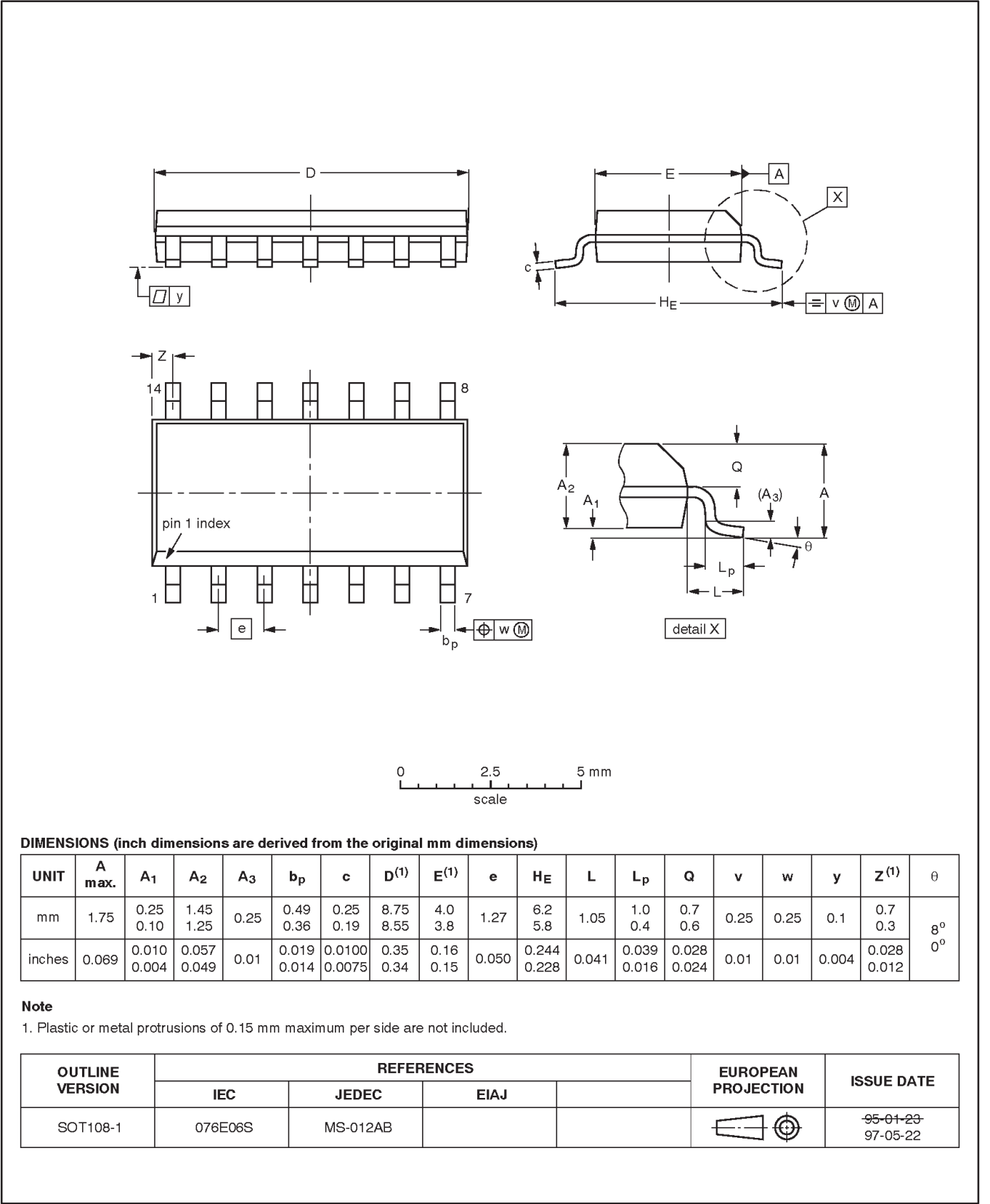


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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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